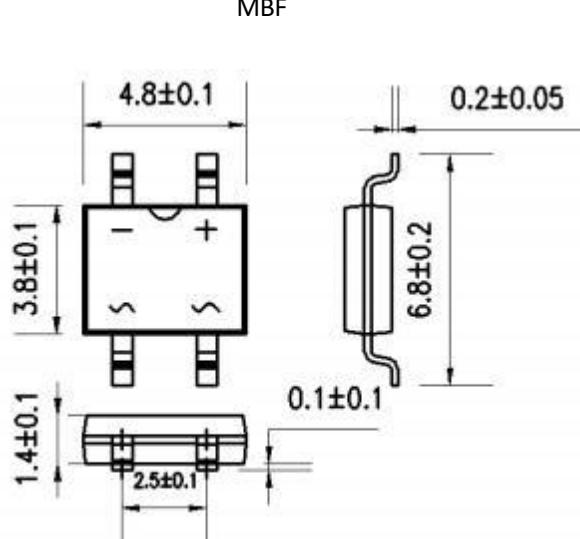
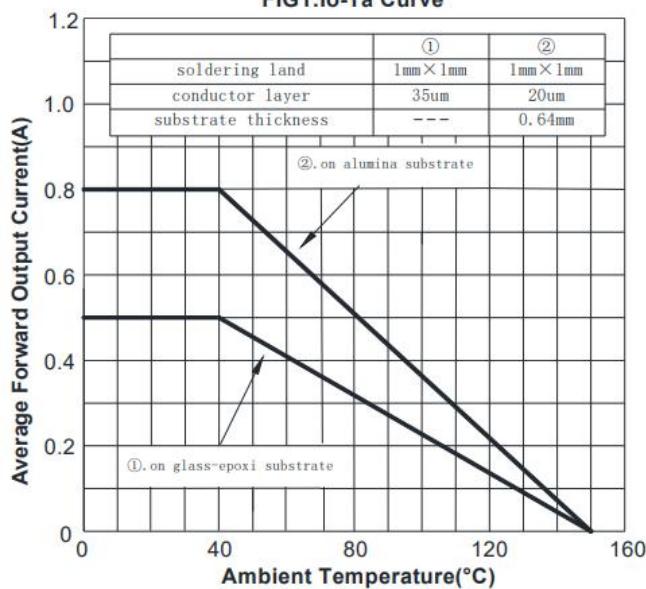
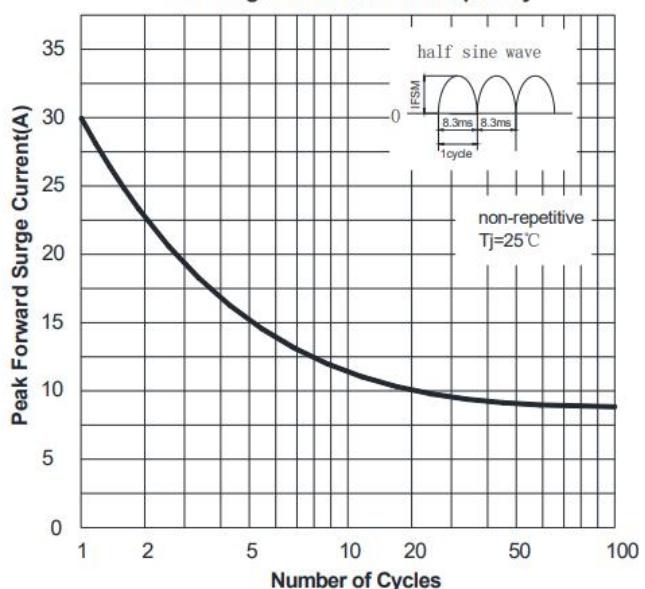
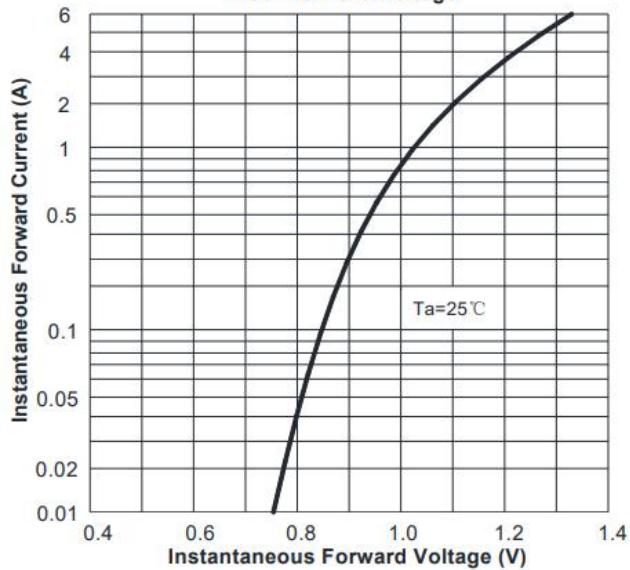


MB05F THRU MB10F

 <p style="text-align: center;">单位: mm</p>	反向电压: 50–1000伏 REVERSE VOLTAGE: 50 to 1000 VOLTS 正向电流: 0.8安培 FORWARD CURRENT: 0.8 AMPERE
	特征 FEATURES <ul style="list-style-type: none"> ● 玻璃钝化芯片 Glass Passivated Die Construction ● 正向浪涌承受能力强 High Forward surge capability ● 低正向压降 Low Forward Voltage Drop ● 高温焊接保证 High temperature soldering guaranteed: 260°C/10 秒 ● 引线和管体皆符合 RoHS 标准 Lead and body according with RoHS standard
	机械数据 Mechanical Data <ul style="list-style-type: none"> ● 封装: MBF 封装 MBF small outline plaskage ● 极性: 按极性激光印字与脚位 As Marked on Case ● 环氧树脂 UL 易燃等级 Epoxy UL:94V-0 ● 安装位置: 任意 Mounting Position: Any

极限值和温度特性(TA=25°C除非另有规定) Ratings at 25°C ambient temperature unless otherwise specified

参数 Parameters	符号 Symbol	MB05F	MB1F	MB2F	MB4F	MB6F	MB8F	MB10F	Units
最大可重复峰值反向电压 Maximum Recurrent Peak Reverse Voltage	V _{RRM}	50	100	200	400	600	800	1000	Volts
最大均方根电压 Maximum RMS Voltage	V _{RMS}	35	70	140	280	420	560	700	Volts
最大直流阻断电压 Maximum DC Blocking oltage	V _{DC}	50	100	200	400	600	800	1000	Volts
最大正向平均整流电流 Maximum Average Forward Rectified Current@Ta=40° C	I(AV)								Amp
正向不重复浪涌电流 8.3ms 单一正弦半波 Peak Forward Surge Current, 8.3ms single half-sine-wave superimposed on rated load	I _{FSM}								Amp
单位时间内承受的最大电流 I ² t Rating for Fusing(t<8.3ms)	I ² t								A ² s
最大正向电压 Maximum Forward Voltage at 0.5A DC and 25°C	V _F								Volts
最大反向电流@VDC Maximum Reverse Current at T _A =25°C	IR								uAmp
最大反向电流@VDC Maximum Reverse Current at T _A =125°C									
典型结电容 VR=4.0V, f=1MHZ Typical Junction Capacitance	C _J								pF
典型热阻 Typical Thermal Resistance	R _{θ JA}								°C/W
工作结温和存储温度 Operating and Storage Temperature Range	T _J , T _{Stg}								°C

特性曲线Characteristic Curves (TA=25 °C unless otherwise noted)
FIG1:Io-Ta Curve

FIG2:Surge Forward Current Capability

FIG3: Forward Voltage

FIG4:Typical Reverse Characteristics
